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Vishay/Siliconix SI7925DN-T1-E3

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Si7925DN

RoHS

COMPLIANT

Vishay Siliconix

Dual P-Channel 12-V (D-S) MOSFET

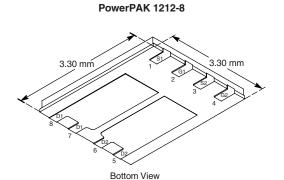
PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)		
	0.042 at V _{GS} = - 4.5 V	- 6.5		
- 12	0.058 at V _{GS} = - 2.5 V	- 5.5		
	0.082 at V _{GS} = - 1.8 V	- 1.2		

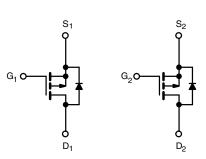
FEATURES

- Halogen-free Option Available
- TrenchFET[®] Power MOSFET: 1.8 V Rated

APPLICATIONS

- Load Switch
- PA Switch
- Battery Switch
- Bi-Directional Switch





Ordering Information: Si7925DN-T1-E3 (Lead (Pb)-free) Si7925DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T	$_{\rm A}$ = 25 °C, unles					
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	- 12		V	
Gate-Source Voltage		V _{GS}	± 8			
Outine Drain Outent (T. 150 %0)d	T _A = 25 °C	– I _D	- 6.5	- 4.8		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		- 4.7	- 3.4	•	
Pulsed Drain Current		I _{DM}	- 20		A	
Continuous Source Current (Diode Conduction) ^a		۱ _S	- 2.1	- 1.1		
	T _A = 25 °C	- P _D	2.5	1.3	W	
Maximum Power Dissipation ^a	T _A = 85 °C		1.5	0.69		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b, c}			260		Ĵ	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manimum lumation to Analyjanta	t ≤ 10 s	P	40	50	
Maximum Junction-to-Ambient ^a	Steady State	R _{thJA}	75	94 °C	°C/W
Maximum Junction-to-Case	Steady State	R _{thJC}	5.6	7	

Notes:

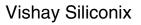
a. Surface Mounted on 1" x 1" FR4 board.

b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



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SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 0.40		- 1.0	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 8 V$			± 100	nA		
Zero Gate Voltage Drain Current	Inne	V _{DS} = - 12 V, V _{GS} = 0 V			- 1			
	IDSS	V_{DS} = - 12 V, V_{GS} = 0 V, T_{J} = 85 °C			- 5	μΑ		
On-State Drain Current ^a	I _{D(on)}	V_{DS} \leq - 5 V, V_{GS} = - 4.5 V	- 20			А		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 6.5 A		0.033	0.042	Ω		
		V _{GS} = - 2.5 V, I _D = - 5.5 A		0.046	0.058			
		V _{GS} = - 1.8 V, I _D = - 1.2 A		0.065	0.082			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 6 V, I _D = - 6.5 A		19		S		
Diode Forward Voltage ^a	V _{SD}	I _S = - 2.1 A, V _{GS} = 0 V		- 0.8	- 1.2	V		
Dynamic ^b								
Total Gate Charge	Qg			11	12			
Gate-Source Charge	Q _{gs}	V_{DS} = - 6 V, V_{GS} = - 4.5 V, I_{D} = - 6.5 A		1.7		nC		
Gate-Drain Charge	Q _{gd}			2.8				
Gate Resistance	Rg			8.2		Ω		
Turn-On Delay Time	t _{d(on)}			20	30			
Rise Time	t _r	V_{DD} = - 6 V, R_L = 6 Ω		50	75	ns		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 1 A, V_GEN = - 4.5 V, R_G = 6 Ω		70	105			
Fall Time	t _f			50	75			
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 2.1 A, dI/dt = 100 A/μs		41	80			

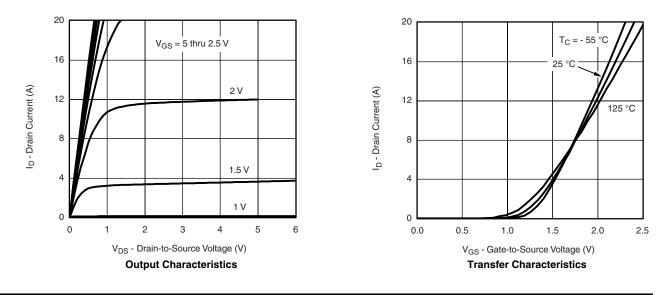
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

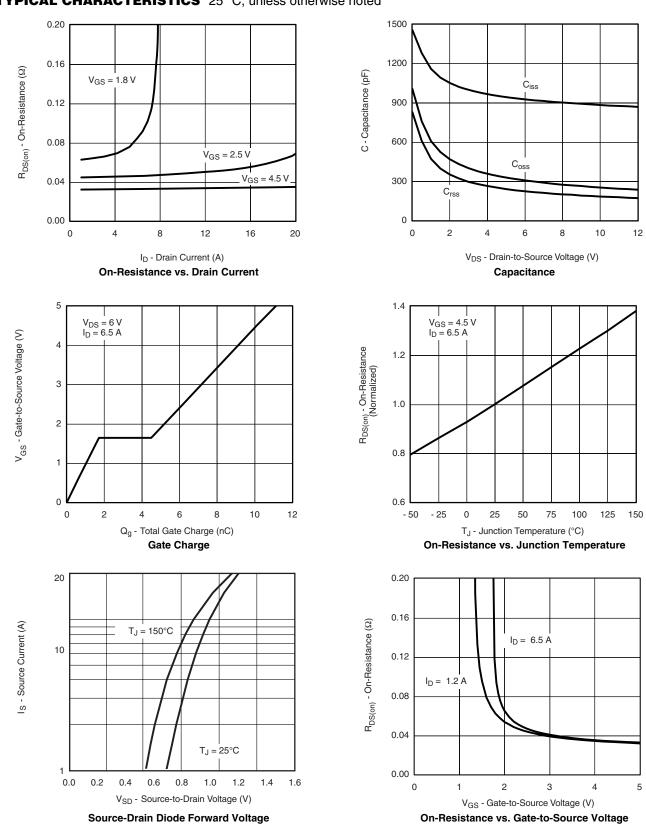






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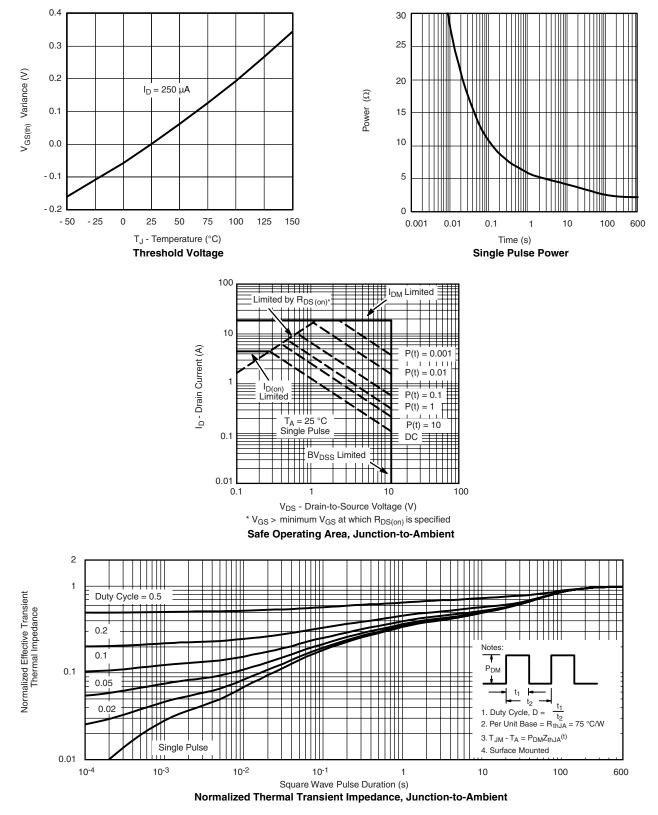


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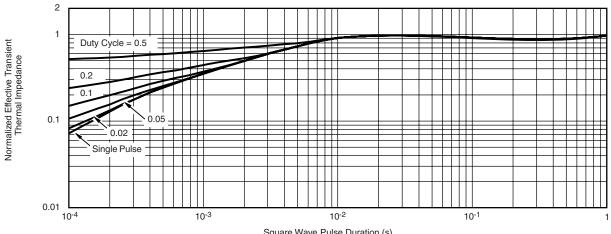




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Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72343.





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